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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









Low-Power, High-Performance DAB/DAB+ Baseband Processor

Description

The Si4614 DAB/DAB+ radio processor provides significant advances in size, power consumption, and performance to enable DAB/DAB+ Radio reception in automotive infotainment systems and car radios. It is designed to work with the high-performance automotive Si479x family of radio tuners.

The low power high performance Si4614 DAB/DAB+ Radio processor provides channel demodulation and source decoding of DAB/DAB+ signals delivering audio and data.

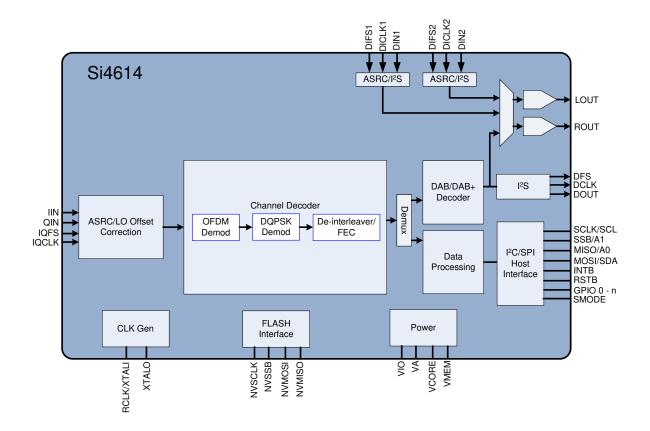
The Si4614 Radio processor provides DAB/DAB+ demodulation and decoding. In addition, the Si4614 provides an integrated clock oscillator or accepts a reference clock and supports a selectable control interface (SPI or I²C). The Si4614 processor system specifies a low minimal bill of materials, notably eliminating an external RAM memory module for channel decoding that is typically required in third party DAB/DAB+ Radio processors.

Features

- DAB/DAB+ demodulator
- Transmission Modes I, II, III, IV detection and decoding
- DAB/DAB+ audio decoder
 - PAD/XPAD outputs available
- FIC decoder
 - Ensemble info
 - Service list
 - Component info
 - Service linking info
- Full support for data services
 - Packet mode
 - Packet mode with Data Groups
 - Enhanced packet mode
 - MOT, TPEG packet outputs
- No external RAM required for channel decoding
- Flash memory interface for application program load
- Support for Si479x Zero-IF digital at 2.048 MS/s
- On-chip crystal oscillator
- Reference clock input
- SPI, I²C control interfaces
- 7x7 mm 48-pin QFN package
- Pb-free/RoHS compliant
- AEC-Q100 qualified

Applications

- Aftermarket car radio systems
- OEM automotive infotainment systems
- OEM automotive PND docking systems



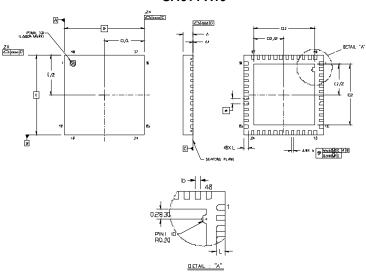


Low-Power, High-Performance DAB/DAB+ **Baseband Processor**

Selected Electrical Specifications

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Analog Supply Voltage	V _A	_	1.71	1.8	2.0	V
Interface Supply Voltage	V _{IO}	_	1.62	1.8	3.6	V
Core Digital Supply Voltage	V _{CORE}	_	1.71	1.8	2.0	V
Memory Supply Voltage	V _{MEM}	_	1.71	1.8	2.0	V
Reference Clock	•	•		•	•	•
Reference Clock Frequency	RCLK		_	36.864	_	MHz
Reference Clock Accuracy			-100	_	100	ppm
Reference Clock Duty Cycle			45	_	55	%
Crystal Oscillator	.	·		•	•	ı
Crystal Oscillator Frequency			_	36.864	_	MHz
Crystal Frequency Tolerance		37.209 MHz	-100	_	100	ppm
Load Capacitance		37.209 MHz	_	_	10	pF
ESR		37.209 MHz	_	_	50	Ω
Ambient Temperature	T _A		-40	25	85	°C

Si4614-A10



Dimension	Min	Nom	Max		
Α	0.80	0.85	0.90		
A1	0.00	0.02	0.05		
b	0.18	0.25	0.30		
D	7.00 BSC				
D2	5.20	5.30	5.40		
е	0.50 BSC				
E	7.00 BSC				
E2	5.20	5.30	5.40		
L	0.30	0.40	0.50		
aaa	0.15				
bbb	0.10				
ddd	0.05				
eee	0.08				

Notes:

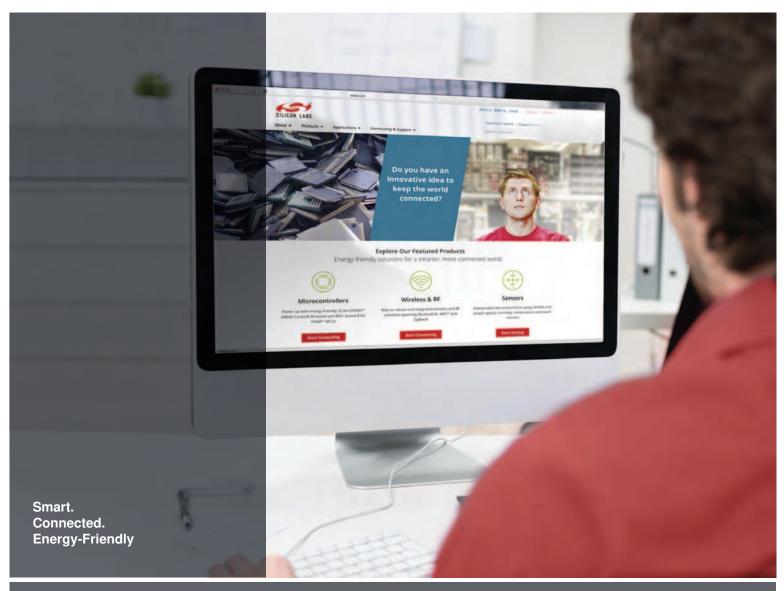
- 1. 2.

- All dimensions are shown in millimeters (mm) unless otherwise noted.

 Dimensioning and Tolerancing per ASME Y14.5M-1994.

 This drawing conforms to the JEDEC Solid State Outline MO-220, Variation VKKD-4.

 Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.









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Silicon Laboratories Inc. 400 West Cesar Chavez Austin, TX 78701